





Absolute Maximum Ratings at Ta=25

Parameter	Maximum Rating	Unit	
Power Dissipation	100	mW	
Collector- Emitter Voltage	30	V	
Emitter- Collector Voltage	5	V	
Operating Temperature	-40 ~+85		
Storage Temperature Range	-45 ~+100		
Lead Soldering Temperature	260 for 5 seconds		

1. Storage

The storage ambient for the LEDs should not exceed 30 °C temperature or 70% relative humidity.

It is recommended that LEDs out of their original packaging are used within three months.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

2. Precautions in handling:

When soldering, leave 2mm of minimum clearance from the resin to the soldering point.

Dipping the resin to solder must be avoided.

Correcting the soldered position after soldering must be avoided.

In soldering, do not apply any stress to the lead frame particularly when heated.

When forming a lead, make sure not to apply any stress inside the resin.

Lead forming must be done before soldering.

It is necessary to cut the lead frame at normal temperature.

3. Caution in ESD:

Static Electricity and surge damages the LED. It is recommend to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

Part No. L	LG-03PT4D94H-302C-T	Page	3 of 9
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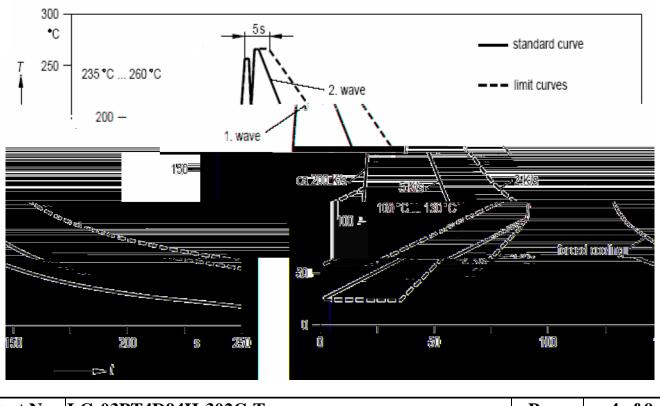
Electrical Optical Characteristics at Ta=25

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	TEST CONDITIONS
Range of Spectral Bandwidth	$\lambda_{0.5}$	840		1100	nm	
Wavelength of Peak Sensitivity	λ_{P}		940		nm	
Collector- Emitter Breakdown Voltage	V _{(BR)CEO}	30			V	I _C =0.1mA Ee=0mW/cm ²
Emitter-Collector Breakdown Voltage	$V_{(BR)ECO}$	5			V	I _R =0.1mA Ee=0 mW/cm ²
Collector- Emitter Saturation Voltage	V _{CE(SAT)}			0.5	V	I _C =0.1 mA Ee=1.0mW/cm ²
Rise Time	T _r		15			Vcc=5V R_L =1K Ω I_C =1mA
Fall Time	T _f		15			Vcc=5V R_L =1K Ω I_C =1mA
Viewing Angle	2θ _{1/2}	45	55	70	Deg.	
Collector Dark Current	I _{CEO}			100	nA	V _{CE} =10V E _e =0 mW/cm ²
On State Collector Current	I _{C(ON)}	6.0	9.0		mA	V_{CE} =5V E _e =1.0mW/cm ² λ_P =940nm

Note:

- 1. 2 $_{1/2}$ is the off-axis angle at which the $I_{C(ON)}$ is half the axial $I_{C(ON)}$.
- 2. The $I_{C(ON)}$ guarantee should be added $\,$ 15% tolerance.

Recommended Wave Soldering Profile

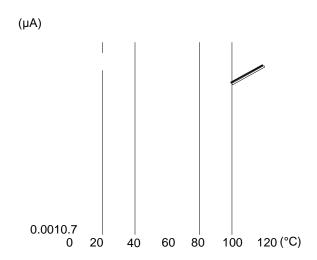


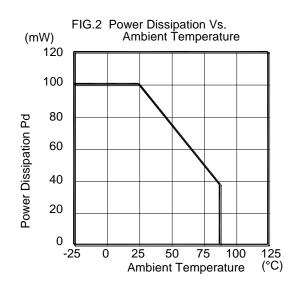
Part No. LG-03PT4D94H-302C-T Page 4 of 9





Typical Electrical / Optical Characteristics Curves (25 Ambient Temperature Unless Otherwise Noted)





(μs)

Tf

Tr

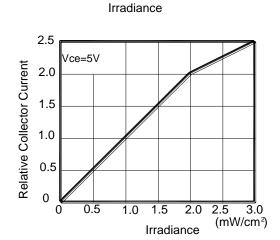
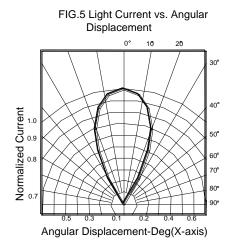
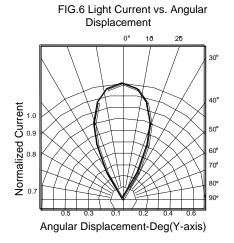


FIG.4 Relative Collector Current Vs.





Part No. LG-03PT4D94H-302C-T Page 5 of 9





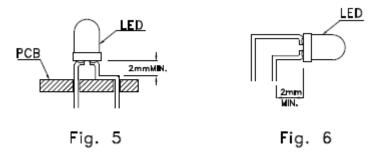
LED MOUNTING METHOD		
1. The lead pitch of the LED must match the pitch of the mounting hole component placement. Lead-forming may be required to insure the lead placement.	oitch match	
hole pitch. Refer to the figure below for proper lead forming procedures	(Fig.1).	
Part No. LG-03PT4D94H-302C-T	Page	6 of 9



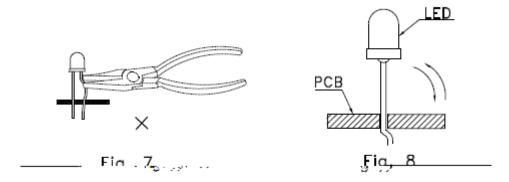


LEAD FORMING PROCEDURES

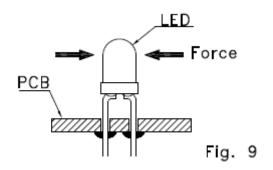
1. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend (Fig.5 and Fig.6).



- 2. Lead forming or bending must be performed before soldering, never during or after soldering.
- 3. Do not stress the LED lens during lead-forming in order to fractures in the lens epoxy and damage the internal structures.
- 4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB (Fig.7).
- 5. Do not bend the leads more than twice (Fig.8).



6. After soldering or other high-temperature assembly, allow the LED to cool down to $50 \, ^{\circ}$ C before applying outside force (Fig.9). In general, avoid placing excess force on the LED to avoid damage. For any questions please consult with LIGHT representative for proper handling procedures.



Part No.	LG-03PT4D94H-302C-T	Page	7 of 9
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